

SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIERS

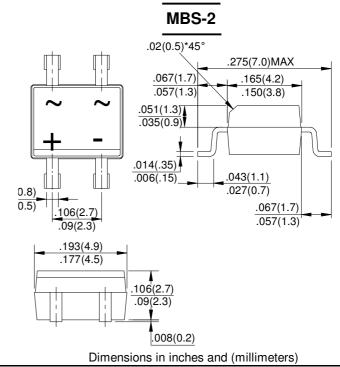
REVERSE VOLTAGE - 50 to 1000 Volts FORWARD CURRENT - 1.0 Ampere

FEATURES

- Rating to 1000V PRV
- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- ●Lead tin plated copper

MECHANICAL DATA

- Polarity:Symbol molded on body
- ●Weight: 0.0044 ounces,0.125 grams
- Mounting position :Any



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25℃ ambient temperature unless otherwise specified.

Single phase, half wave ,60Hz, resistive or inductive load.

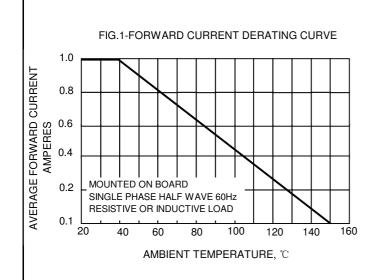
For capacitive load, derate current by 20%

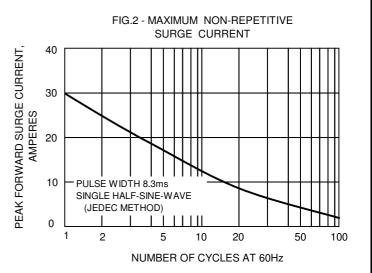
CHARACTERISTICS	SYMBOL	MB105S	MB11S	MB12S	MB14S	MB16S	MB18S	MB110S	UNIT
Maximum Recurrent Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current (Note 1) @Ta=40 °C	I(AV)	1							Α
Peak Forward Surge Current 8.3ms Single Half Sine-Wave Super Imposed on Rated Load(JEDEC Method)	IFSM	30							Α
Peak Forward Voltage at 1.0A DC	VF	1.1						٧	
Maximum DC Reverse Current @TJ=25°C at Rated DC Bolcking Voltage @TJ=125°C	lr	5.0 500							μA
Typical Junction Capacitance Per Element (Note2)	CJ	15							pF
Typical Thermal Resistance (Note3)	Rejc	75						°C/W	
Operating Temperature Range	TJ	-55 to +150						$^{\circ}$	
Storage Temperature Range	Тѕтс	-55 to +150							$^{\circ}\!\mathbb{C}$

NOTES:1.Mounted on P.C. board.

- 2.Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
- 3. Thermal resistance junction to case







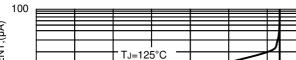


FIG.3-TYPICAL REVERSE CHARACTERISTICS

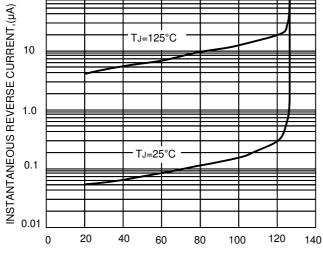






FIG.4-TYPICAL FORWARD CHARACTERISTICS

